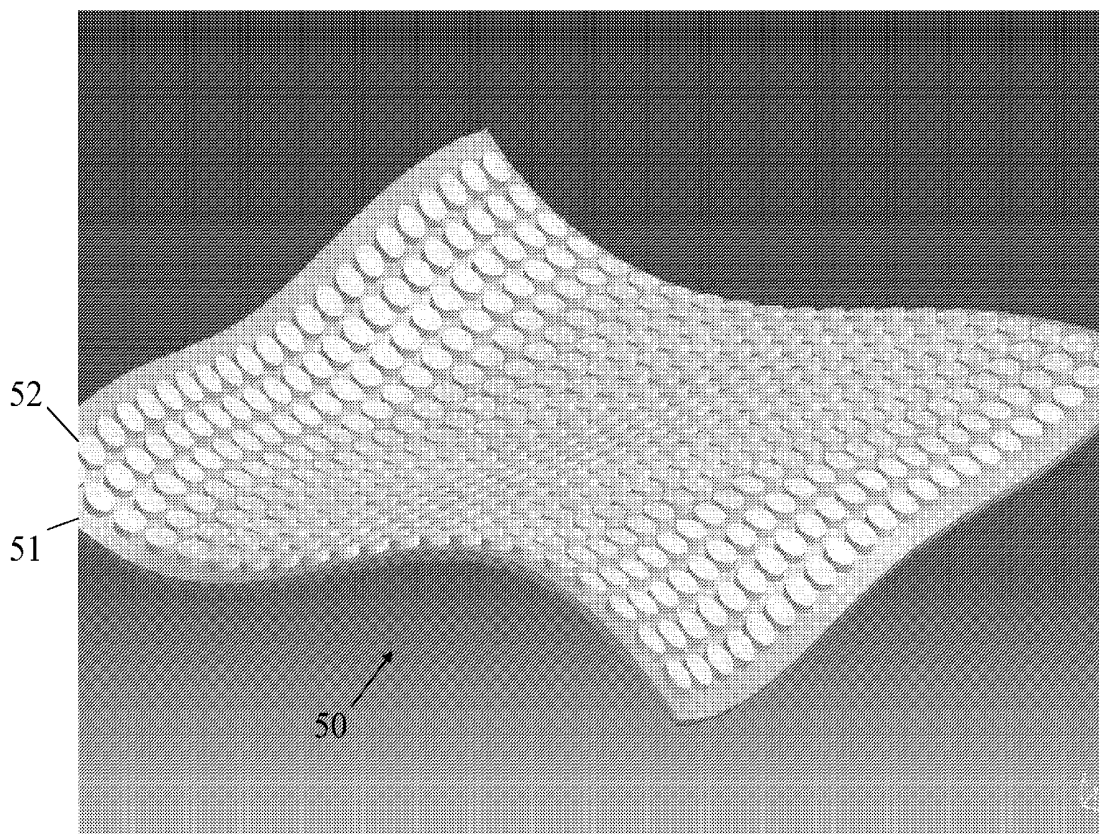




US 20080086056A1

(19) **United States**(12) **Patent Application Publication**
CHANG et al.(10) **Pub. No.: US 2008/0086056 A1**(43) **Pub. Date: Apr. 10, 2008**(54) **MICRO ULTRASONIC TRANSDUCERS**(22) Filed: **Oct. 10, 2007**(75) Inventors: **Ming-Wei CHANG**, Taichung Hsien
(TW); **Hsu-Cheng DENG**, Hsinchu
City (TW); **Tien-Chu FAN**, Taichung
City (TW); **Chih-Min LAI**, Miaoli
County (TW); **Gwo-Shiang LEE**,
Taipei Hsien (TW); **Chia-Lin CHIU**,
Taipei Hsien (TW)**Related U.S. Application Data**(63) Continuation-in-part of application No. 10/648,495,
filed on Aug. 25, 2003, now abandoned.**Publication Classification**(51) **Int. Cl.**
A61B 8/13 (2006.01)(52) **U.S. Cl.** **600/459**Correspondence Address:
Akin Gump LLP - Silicon Valley
3000 El Camino Real
Two Palo Alto Square, Suite 400
Palo Alto, CA 94306 (US)**ABSTRACT**(73) Assignee: **INDUSTRIAL TECHNOLOGY**
RESEARCH INSTITUTE, Hsinchu
(TW)An ultrasonic transducer comprising a flexible membrane, a
first electrode in the flexible membrane, a second electrode
in the flexible membrane, and a chamber in the flexible
membrane between the first electrode and the second elec-
trode.(21) Appl. No.: **11/870,396**

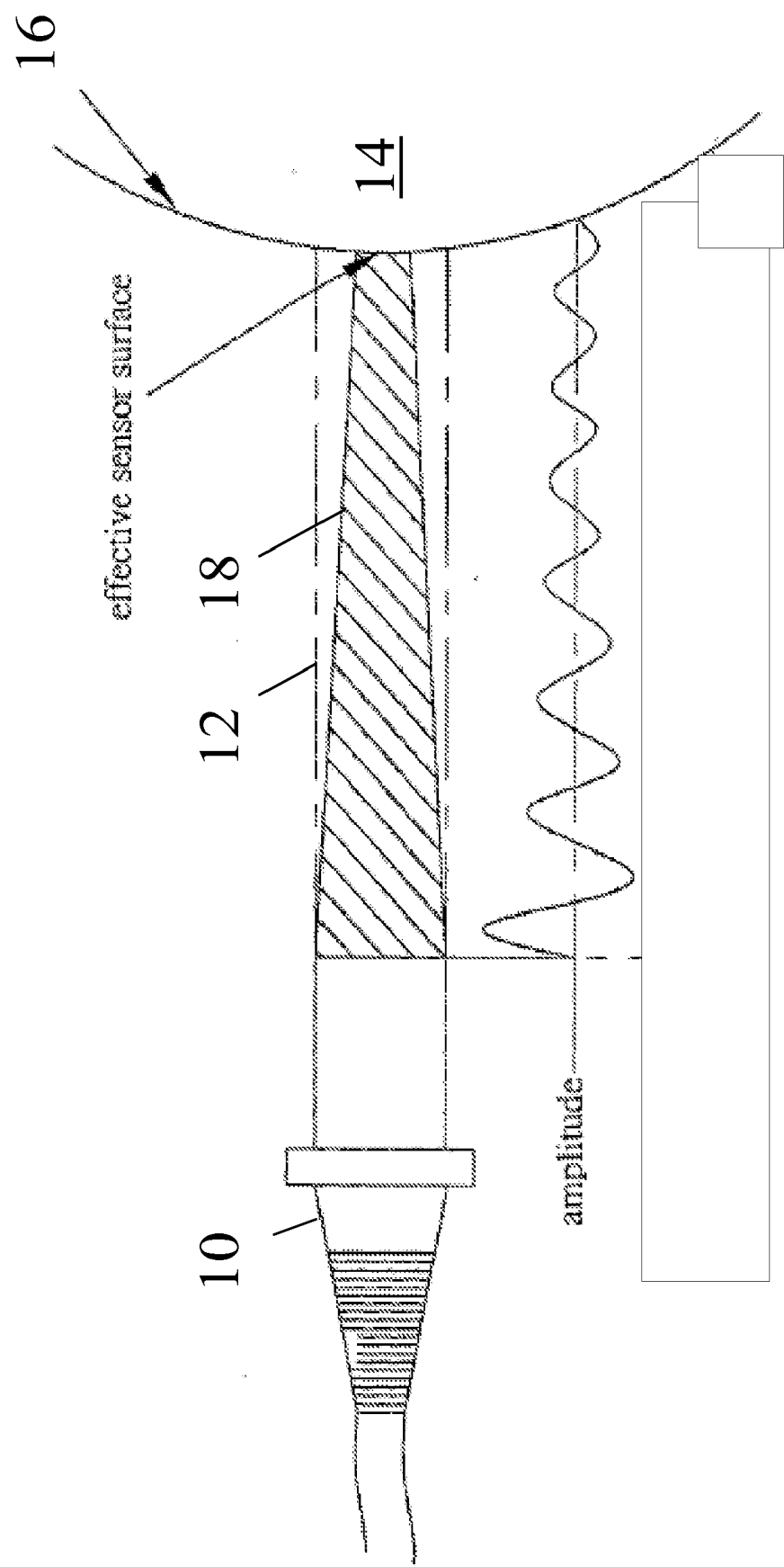


FIG. 1 (PRIOR ART)

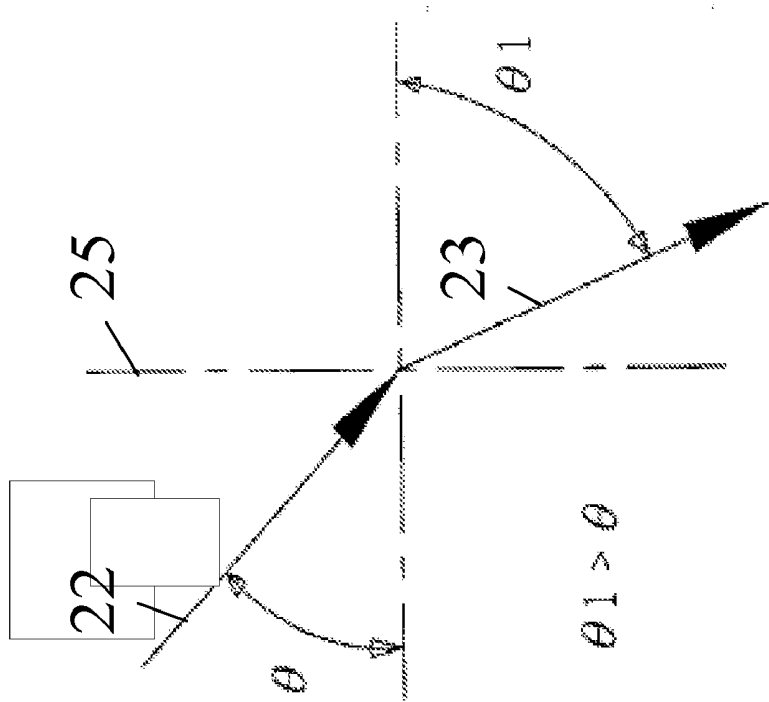


FIG. 2B (PRIOR ART)

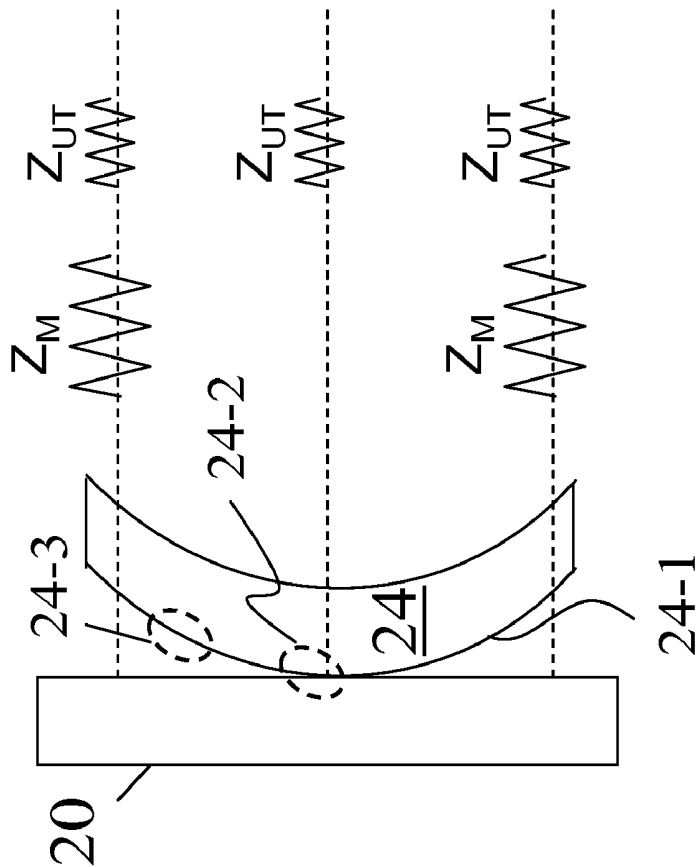


FIG. 2A (PRIOR ART)

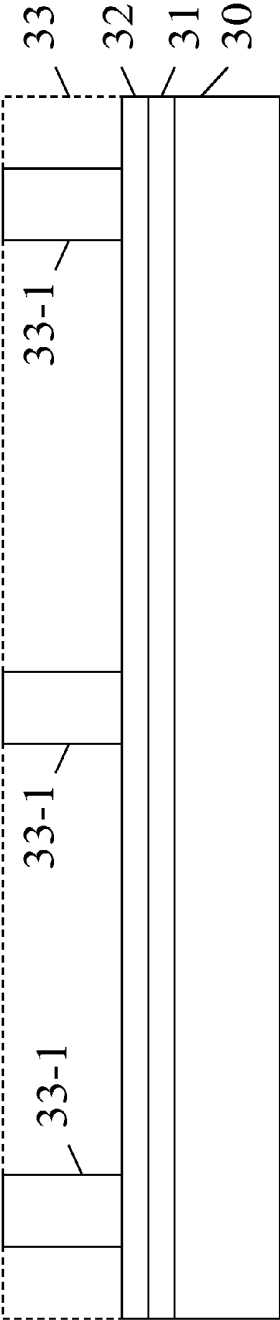


FIG. 3A

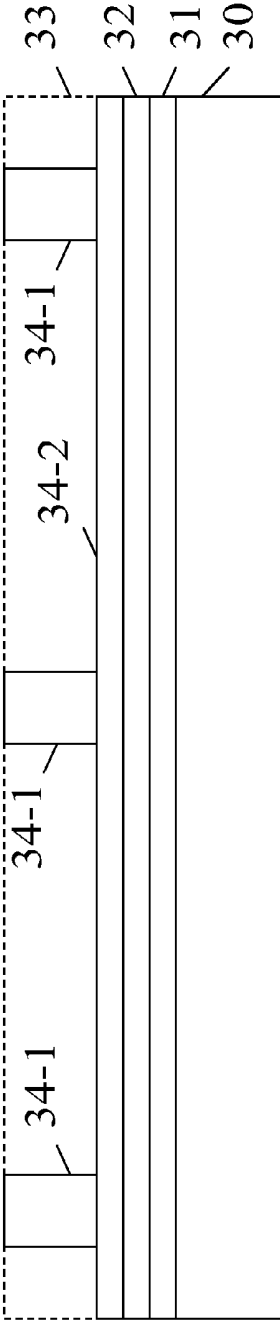


FIG. 3A-1

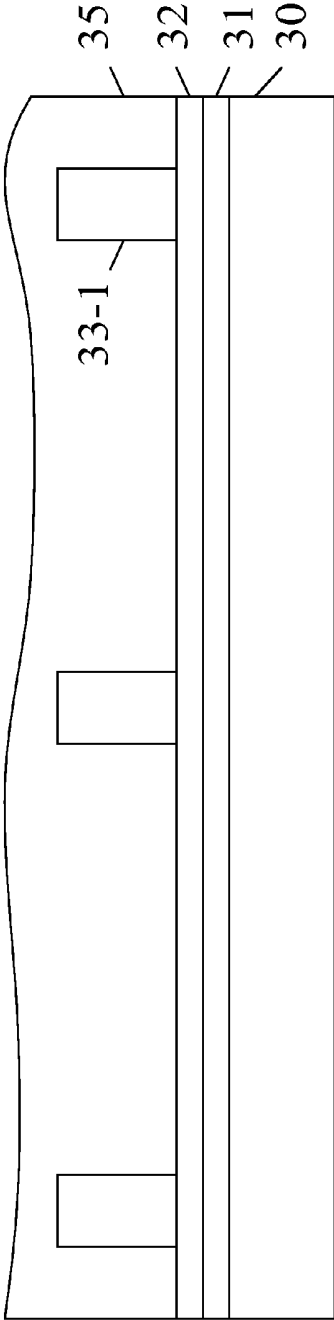


FIG. 3B

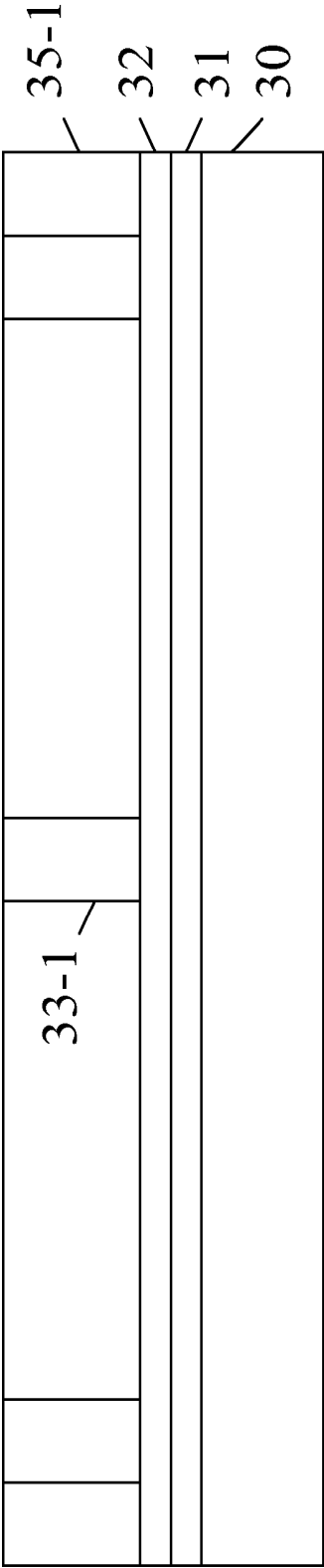


FIG. 3C

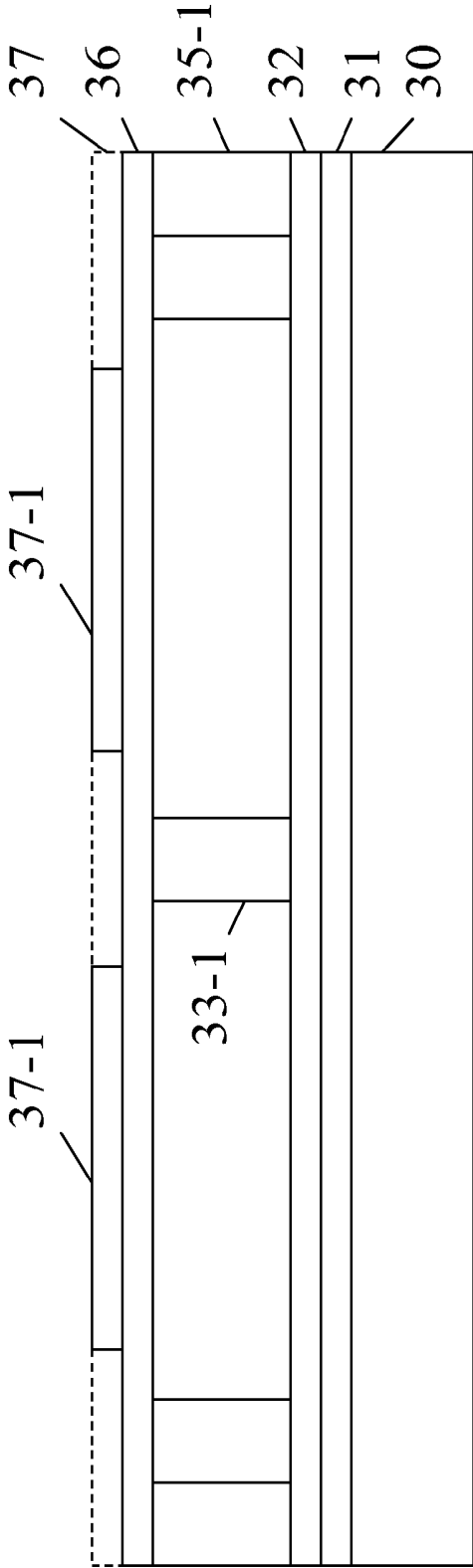
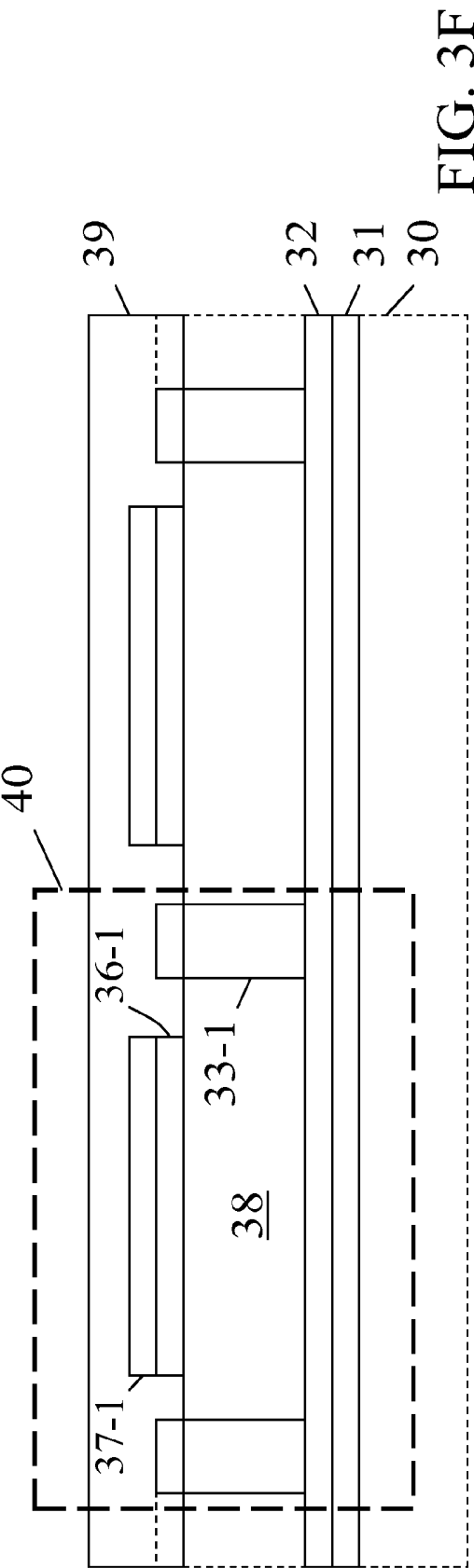
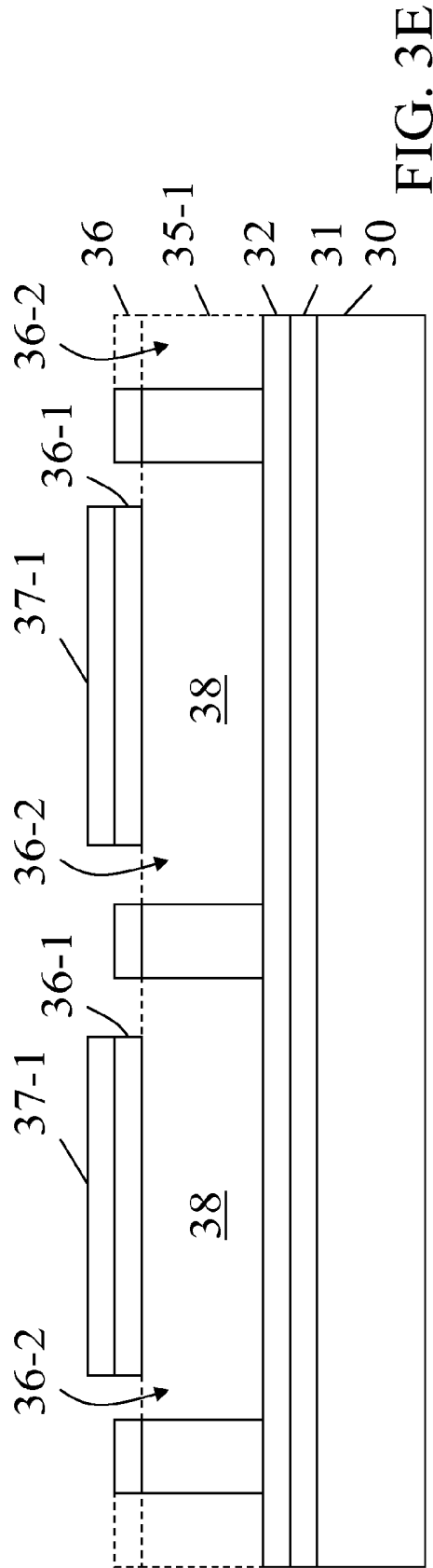
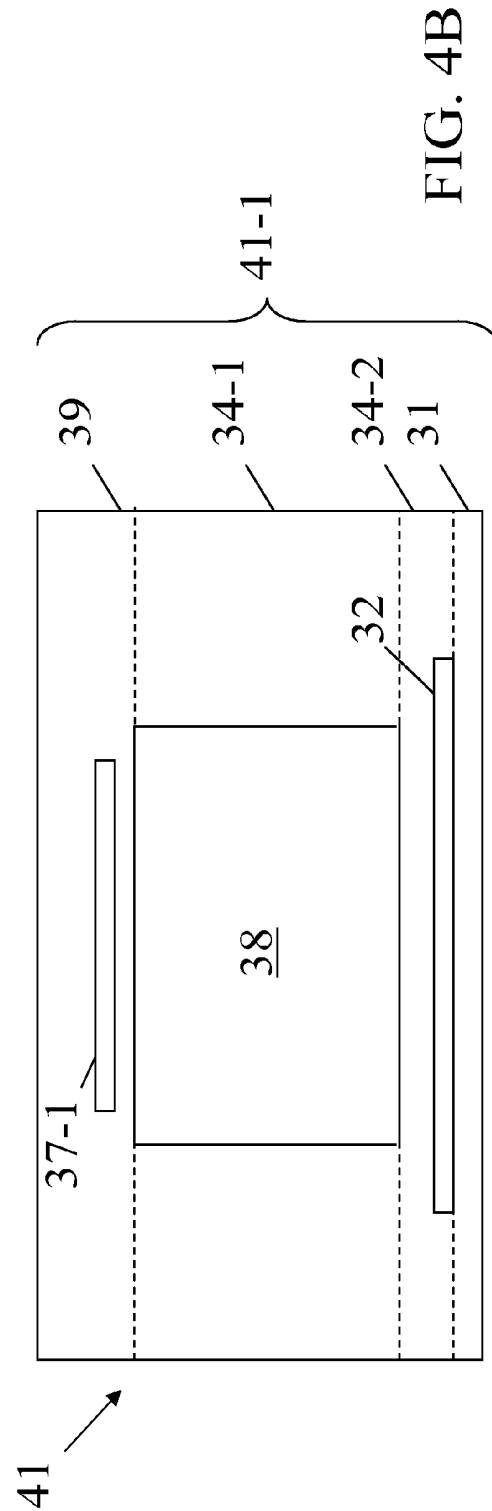
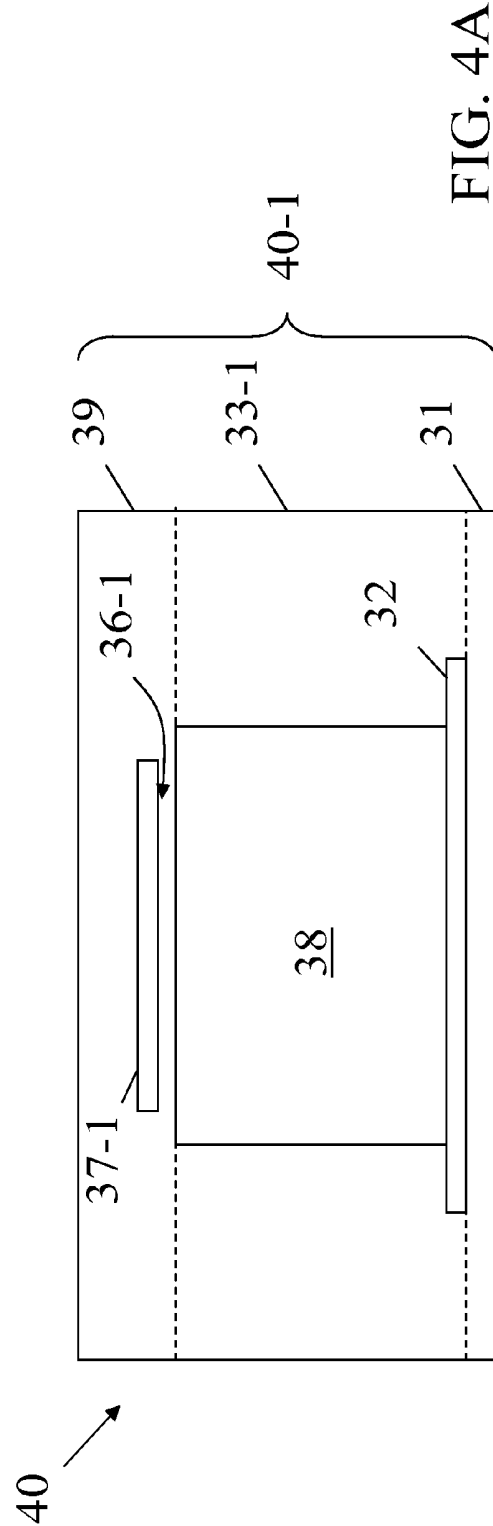


FIG. 3D





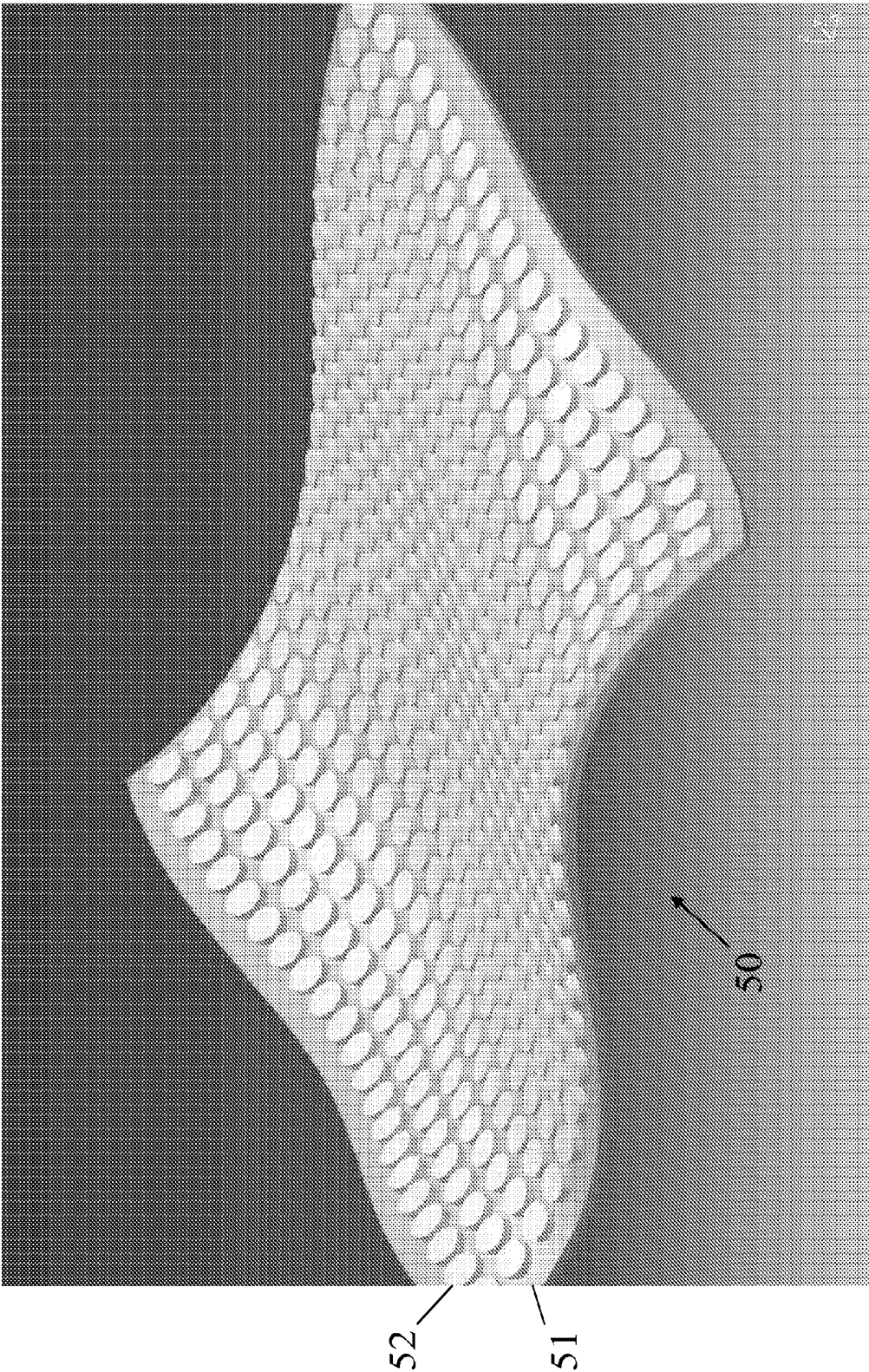


FIG. 5

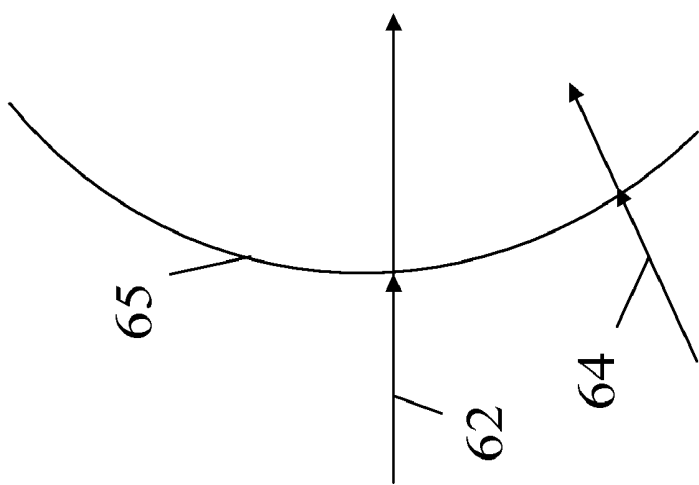


FIG. 6B

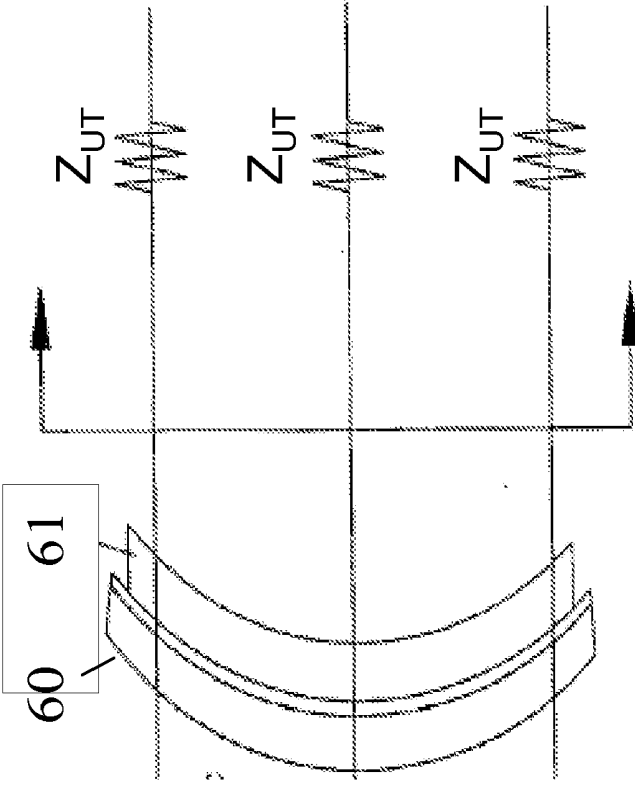


FIG. 6A

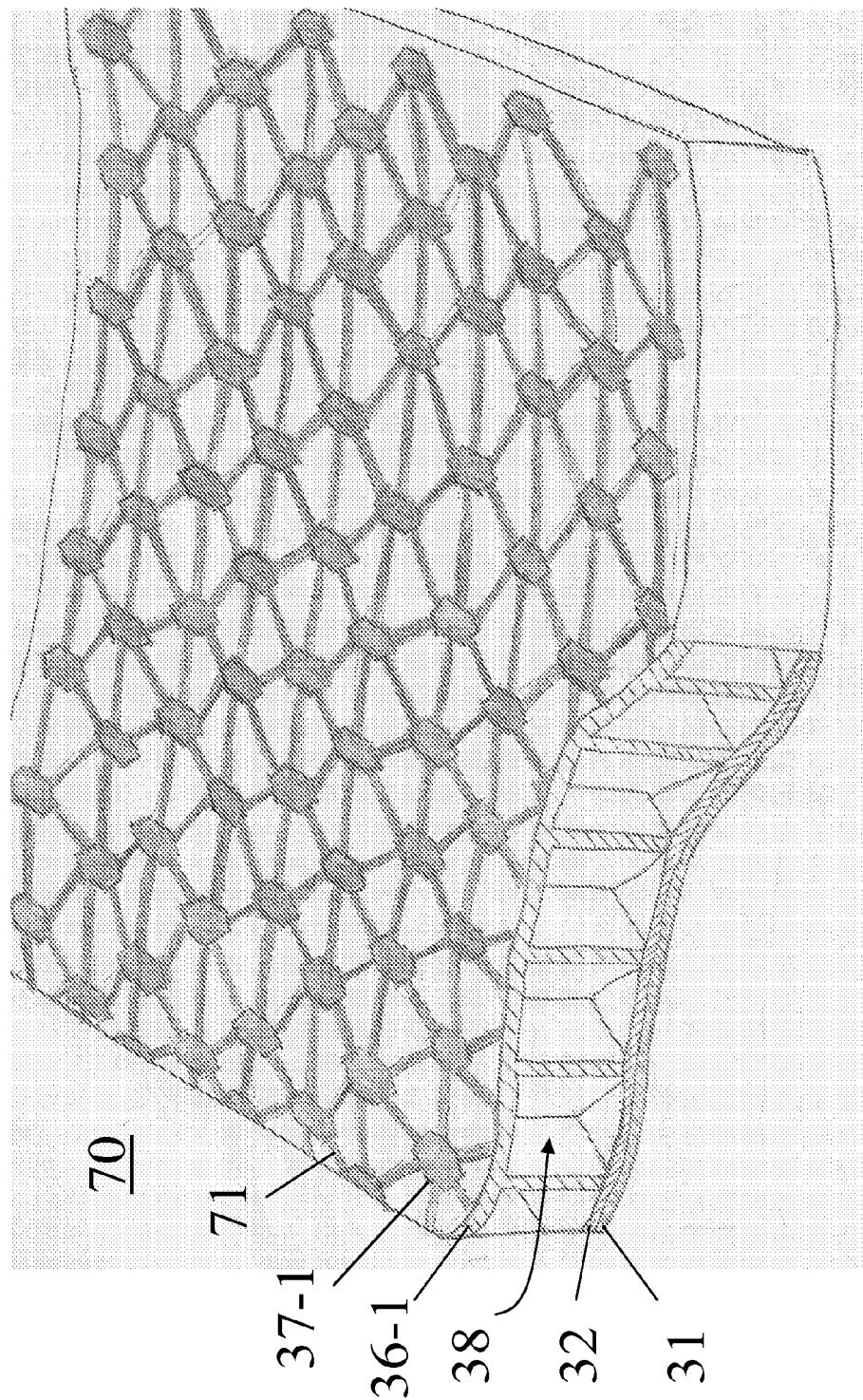


FIG. 7

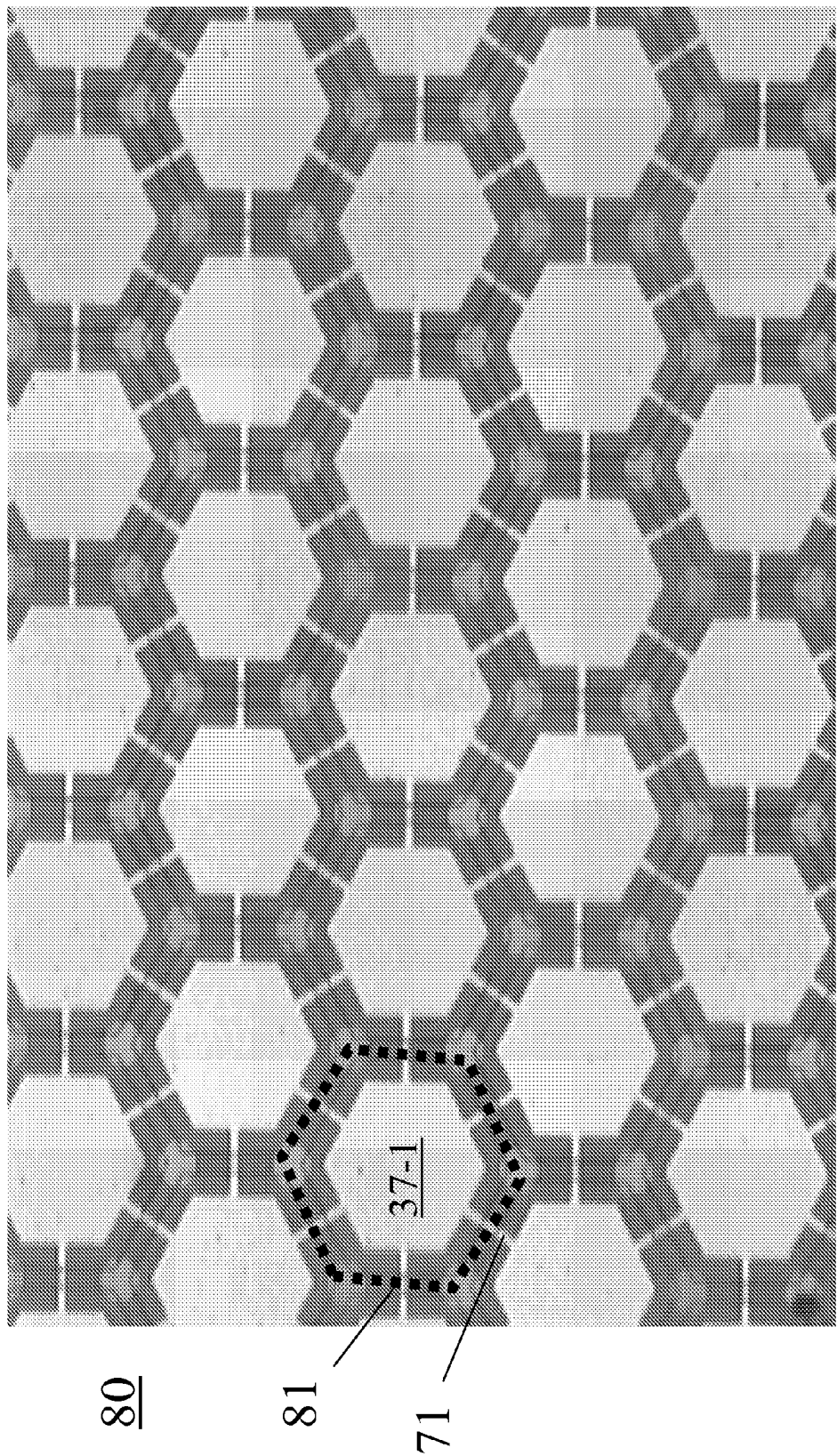


FIG. 8

MICRO ULTRASONIC TRANSDUCERS

CROSS-REFERENCE TO RELATED APPLICATIONS

[0001] This application is a continuation-in-part of U.S. patent application Ser. No. 10/648,495, filed Aug. 25, 2003, which is herein incorporated by reference.

FIELD OF THE INVENTION

[0002] The present invention relates generally to an ultrasonic transducer and, more particularly, to a flexible capacitive ultrasonic transducer.

BACKGROUND OF THE INVENTION

[0003] Ultrasonic sensing devices have been widely used in medical, military and aerospace industries because they have the advantages of non-invasive evaluation, real-time response, relatively high resolution and portability. For example, ultrasonic imaging systems are capable of obtaining information from surrounding means or from human body, based on the use of elastic waves at ultrasonic frequency. An ultrasonic transducer is often one of the important components in an ultrasonic sensing device. The majority of known ultrasonic transducers are realized by using piezoelectric ceramic. A piezoelectric transducer is generally used to obtain information from solid materials because the acoustic impedance of piezoelectric ceramic is of the same magnitude order as those of the solid materials. However, the piezoelectric transducer may not be ideal for obtaining information from fluids because of significant impedance mismatch between piezoelectric ceramic and fluids, for example, tissues of the human body.

[0004] FIG. 1 is a schematic diagram illustrating the issue of attenuation with an ultrasonic transducer 10 in the prior art. Referring to FIG. 1, the ultrasonic transducer 10 may transmit an ultrasonic wave 12 through a medium toward an object 14 having a curved surface 16, and receive a reflected wave 18 from the curved surface 16 of the object 14. The medium may include a solid or fluid, which may attenuate the ultrasonic wave 12 and the reflected wave 18. Furthermore, the effective sensor area, where a reflected wave is able to be received by the ultrasonic transducer 10, may depend on the surface topology of the object 14. In the present example, as compared to a planar surface, the effective sensor area of the curved surface 16, for example, the skin of a human body, may be reduced. Generally, the attenuation may become more significant and the effective sensor area may decrease as the distance between the ultrasonic transducer 10 and the object 14 increases.

[0005] FIG. 2A is a schematic diagram illustrating the issue of impedance mismatch with an ultrasonic transducer 20 in the prior art. Referring to FIG. 2A, the ultrasonic transducer 20 may contact an object 24 having a curved surface 24-1 but may not be able to conform to the curved surface 24-1 of the object 24, which may incur the issue of impedance mismatch. For the purpose of illustration, it may be assumed that an impedance level at a contact region 24-2 where the ultrasonic transducer 20 contacts the curved surface 24-1 is Z_{UT} , which may be approximately an inherent impedance of the ultrasonic transducer 20. At a non-contact region 24-3, however, an additional medium such as air or other couplant may exist. Such an additional medium

may cause an extra impedance Z_M , resulting in impedance mismatch between the contact region 24-2 and the non-contact region 24-3.

[0006] FIG. 2B is a diagram illustrating refraction of an ultrasonic wave in accordance with Snell's law. Referring to FIG. 2B, refraction may occur when an incident ultrasonic wave 22 passes through an interface 25 between two media of different refractive indices. For example, the incident ultrasonic wave 22 may travel in air while a refractive ultrasonic wave 23 may travel in tissue. The angle of incidence " θ " may be smaller than the angle of refraction " θ_1 " when the refractive index of the tissue is smaller than that of air. The refraction may cause attenuation of the refractive ultrasonic wave 23 as compared to the incident ultrasonic wave 22 in amplitude. The refraction and in turn the attenuation may be aggravated when the interface 25 is a curved surface.

BRIEF SUMMARY OF THE INVENTION

[0007] A novel ultrasonic transducer is disclosed, which may obviate one or more problems resulting from the limitations and disadvantages of the prior art.

[0008] Examples of the present invention may provide an ultrasonic transducer comprising a flexible membrane, a first electrode in the flexible membrane, a second electrode in the flexible membrane, and a chamber in the flexible membrane between the first electrode and the second electrode.

[0009] Some examples of the present invention may also provide an ultrasonic transducer comprising a first flexible layer, a first conductive layer over the first flexible layer, a second flexible layer over the first conductive layer, a chamber in the second flexible layer, a third flexible layer over the chamber, and a second conductive layer in the third flexible layer. A portion of the third flexible layer between the second conductive layer and the chamber is capable of generating acoustic waves in response to a voltage applied across the first conductive layer and the second conductive layer.

[0010] Examples of the present invention may further provide an ultrasonic transducer array comprising a flexible substrate, a first conductive layer on the flexible substrate, and a number of ultrasonic transducers on the first conductive layer. Each of the number of ultrasonic transducers comprises a flexible membrane over the first conductive layer, a second conductive layer in the flexible membrane, and a chamber in the membrane between the first conductive layer and the second conductive layer.

[0011] Examples of the present invention may still provide an ultrasonic transducer array comprising a first flexible layer, a first conductive layer on the first flexible layer, and a number of ultrasonic transducers on the first conductive layer. Each of the number of ultrasonic transducers comprises a second flexible layer over the first conductive layer, a chamber in the second flexible layer, a third flexible layer over the chamber, and a second conductive layer in the third flexible layer. A portion of the third flexible layer between the second conductive layer and the chamber is capable of generating acoustic waves in response to a voltage applied across the first conductive layer and the second conductive layer.

[0012] Additional features and advantages of the present invention will be set forth in part in the description which

follows, and in part will be obvious from the description, or may be learned by practice of the invention. The features and advantages of the invention will be realized and attained by means of the elements and combinations particularly pointed out in the appended claims.

[0013] It is to be understood that both the foregoing general description and the following detailed description are exemplary and explanatory only and are not restrictive of the invention, as claimed.

[0014] The accompanying drawings, which are incorporated in and constitute a part of this specification, illustrate one example of the present invention and together with the description, serves to explain the principles of the invention.

BRIEF DESCRIPTION OF THE SEVERAL VIEWS OF THE DRAWINGS

[0015] The foregoing summary, as well as the following detailed description of the invention, will be better understood when read in conjunction with the appended drawings. For the purpose of illustrating the invention, there are shown in the drawings examples which are presently preferred. It should be understood, however, that the invention is not limited to the precise arrangements and instrumentalities shown.

[0016] In the drawings:

[0017] FIG. 1 is a schematic diagram illustrating the issue of attenuation with an ultrasonic transducer in the prior art;

[0018] FIG. 2A is a schematic diagram illustrating the issue of impedance mismatch with an ultrasonic transducer in the prior art;

[0019] FIG. 2B is a diagram illustrating refraction of an ultrasonic wave in accordance with Snell's law;

[0020] FIGS. 3A to 3F are cross-sectional diagrams illustrating a method of manufacturing an ultrasonic transducer consistent with an example of the present invention;

[0021] FIG. 3A-1 is a cross-sectional diagram illustrating a method of manufacturing an ultrasonic transducer consistent with another example of the present invention;

[0022] FIG. 4A is a cross-section view of an ultrasonic transducer consistent with an example of the present invention;

[0023] FIG. 4B is a cross-section view of an ultrasonic transducer consistent with another example of the present invention;

[0024] FIG. 5 is a three-dimensional view of an ultrasonic transducer array consistent with an example of the present invention;

[0025] FIG. 6A is a schematic diagram illustrating the operation of an ultrasonic transducer consistent with an example of the present invention;

[0026] FIG. 6B is a diagram illustrating ultrasonic waves from an array of the ultrasonic transducers illustrated in FIG. 6A;

[0027] FIG. 7 is a perspective view of an ultrasonic transducer consistent with an example of the present invention; and

[0028] FIG. 8 is a top planar view of an ultrasonic transducer array consistent with an example of the present invention.

DETAILED DESCRIPTION OF THE INVENTION

[0029] In this detailed description, for purposes of explanation, numerous specific details are set forth to illustrate examples of the present invention. One skilled in the art will appreciate, however, that examples of the present invention may be practiced without these specific details. Furthermore, one skilled in the art can readily appreciate that the specific sequences in which methods are presented and performed are illustrative and it is contemplated that the sequences can be varied and still remain within the spirit and scope of embodiments of the present invention.

[0030] FIGS. 3A to 3F are cross-sectional diagrams illustrating a method of manufacturing an ultrasonic transducer consistent with an example of the present invention. Referring to FIG. 3A, a substrate 30 may be provided to serve as a supporting base on which an ultrasonic transducer array may be fabricated, and may be removed after the ultrasonic transducer array is fabricated. The substrate 30 may include a silicon substrate having a thickness ranging from approximately 200 to 600 micrometer (μm). In one example, the thickness of the substrate 30 may be approximately 525 μm .

[0031] A first flexible layer 31, which may eventually serve as a flexible base of the ultrasonic transducer array, may be formed on the substrate 30 by a coating, blading or other suitable processes. The first flexible layer 31 may include a polymeric material selected from one of polyimide, parylene and photoresist such as AZ-4620, polymethylmethacry (PMMA), SU-8, SP-341 and JSR. The first flexible layer 31 may have a thickness ranging from approximately 20 to 400 μm . In one example according to the present invention, the thickness of the first flexible layer 31 may be approximately 90 μm .

[0032] Next, a first conductive layer 32 may be formed on the first flexible layer 31 by a sputtering process or other suitable processes. The first conductive layer 32, which may eventually serve as a first electrode for an ultrasonic transducer of the array being fabricated, may include a metal material selected from one of aluminum (Al), aurum (Au), platinum (Pt) and copper (Cu). The first conductive layer 32 may have a thickness ranging from approximately 0.1 to 0.6 μm .

[0033] A second flexible layer 33 may be formed on the first conductive layer 32 by a coating process or other suitable processes. The second flexible layer 33 may then be patterned and etched by, for example, a photolithographic process to form a patterned second flexible layer including a number of flexible supports 33-1. In the present example, the patterned second flexible layer may expose portions of the first conductive layer 32. In another example, as illustrated in FIG. 3A-1, the first conductive layer 32 may not be exposed. FIG. 3A-1 is a cross-sectional diagram illustrating a method of manufacturing an ultrasonic transducer consistent with another example of the present invention. Referring to FIG. 3A-1, the method may be similar to that described and illustrated with reference to FIG. 3A except that, for example, a patterned second flexible layer may include a flexible base 34-2 on the first conductive layer 32

and a number of flexible supports **34-1** on the flexible base **34-2**. The patterned second flexible layer illustrated in FIGS. **3A** and **3A-1** may include a polymeric material selected from one of polyimide, parylene and photoresist such as AZ-4620, polymethylmethacry (PMMA), SU-8, SP-341 and JSR. The thickness of the patterned second flexible layer, or the height of the flexible supports **33-1** and **34-1**, may range from approximately 0.5 to 5 μm .

[0034] Referring to FIG. **3B**, a second conductive layer **35** may be formed over the patterned second flexible layer by a sputtering process or other suitable processes. The second conductive layer **35** may serve as a sacrificial layer and may be removed in a subsequent process. In one example according to the present invention, the second conductive layer **35** may include copper (Cu).

[0035] Referring to FIG. **3C**, the second conductive layer **35** may be planarized by, for example, a lapping or chemical-mechanical polishing (CMP) process or other suitable processes to form a sacrificial conductive layer **35-1**. The sacrificial conductive layer **35-1** may be substantially flush with the flexible supports **33-1** or **34-1**.

[0036] Referring to FIG. **3D**, a third flexible layer **36** may be formed on the sacrificial conductive layer **35-1** by a coating process or other suitable processes. The third flexible layer **36** may include a polymeric material selected from one of polyimide, parylene and photoresist such as AZ-4620, polymethylmethacry (PMMA), SU-8, SP-341 and JSR. The thickness of the third flexible layer **36** may range from approximately 0.5 to 2 μm .

[0037] Next, a third conductive layer **37** may be formed on the third flexible layer **36** by a sputtering process or other suitable processes. The third conductive layer **37** may then be patterned and etched to form a patterned third conductive layer including a number of conductors **37-1**. Each of the conductors **37-1**, which may eventually serve as a second electrode for an ultrasonic transducer of the array being fabricated, may include a metal material selected from one of aluminum (Al), aurum (Au), platinum (Pt) and copper (Cu). The thickness of the patterned third conductive layer may range from approximately 0.1 to 0.6 μm .

[0038] Referring to FIG. **3E**, the third flexible layer **36** may be etched to form a number of flexible units **36-1**, exposing portions of the sacrificial conductive layer **35-1** through openings **36-2**. The sacrificial conductive layer **35-1** may then be removed through the openings **36-2** by an etching process, resulting in a number of chambers **38** each of which corresponds to one of the number of flexible units **36-1** and in turn one of the number of conductors **37-1**.

[0039] Referring to FIG. **3F**, a fourth flexible layer **39** may be formed over the patterned third conductive layer by a coating process or other suitable processes. Subsequently, the substrate **30** may be stripped. The fourth flexible layer **39** may include a polymeric material selected from one of polyimide, parylene and photoresist such as AZ-4620, polymethylmethacry (PMMA), SU-8, SP-341 and JSR. The thickness of the fourth flexible layer **39** may range from approximately 2 to 6 μm . In the present example, each of the chambers **38** may be defined by one set of the supports **33-1**, one of the flexible units **36-1** and the first conductive layer **32**. In another example, also referring to FIG. **3A-1**, each of the chambers **38** may be defined by one set of the supports **34-1**, one of the flexible units **36-1** and the flexible base **34-2**.

[0040] FIG. **4A** is a cross-section view of an ultrasonic transducer **40** consistent with an example of the present

invention. Referring to FIG. **4A**, also referring to a dashed box illustrated in FIG. **3F**, the ultrasonic transducer **40** may include the first electrode **32** embedded in a flexible membrane **40-1**, the second electrode **37-1** embedded in the flexible membrane **40-1**, and the chamber **38** between the first electrode **32** and the second electrode **37-1** in the flexible membrane **40-1**. The flexible membrane **40-1** may comprise the first flexible layer **31**, the supports **33-1**, the flexible unit **36-1** and the fourth flexible layer **39**, which are made of substantially the same polymeric material. In the ultrasonic transducer **40**, the first electrode **32** is exposed to the chamber **38**. Furthermore, when a suitable alternating current (AC) voltage or direct current (DC) voltage is applied across the first electrode **32** and the second electrode **37-1**, an electrostatic force may cause the fourth flexible layer **39**, or specifically the third flexible unit **36-1** between the chamber **38** and the second electrode **37-1**, to oscillate and generate acoustic waves. The third flexible unit **36-1**, which has been described and illustrated with reference to FIGS. **3E** and **3F**, is integrated into the flexible membrane **40-1** together with the first flexible layer **31**, the supports **33-1** and the fourth flexible layer **39**.

[0041] FIG. **4B** is a cross-section view of an ultrasonic transducer **41** consistent with another example of the present invention. Referring to FIG. **4B**, also referring to FIG. **3A-1**, the ultrasonic transducer **41** may include the first electrode **32** embedded in a flexible membrane **41-1**, the second electrode **37-1** embedded in the flexible membrane **41-1**, and the chamber **38** embedded in the flexible membrane **41-1** between the first electrode **32** and the second electrode **37-1**. The flexible membrane **41-1** may comprise the first flexible layer **31**, the supports **34-1**, the flexible base **34-2**, the flexible unit **36-1** and the fourth flexible layer **39**, which are made of substantially the same polymeric material.

[0042] FIG. **5** is a three-dimensional view of an ultrasonic transducer array **50** consistent with an example of the present invention. The ultrasonic transducer array **50** may include a flexible substrate **51** and a number of ultrasonic transducers **52** formed on the flexible substrate **51**. In one example according to the present invention, each of the ultrasonic transducers **52** may be similar to the ultrasonic transducers **40** and **41** described and illustrated with reference to FIGS. **4A** and **4B**, respectively. In another example, each of the ultrasonic transducers **52** may include a number of transducer units each being similar to the ultrasonic transducers **40** and **41** described and illustrated with reference to FIGS. **4A** and **4B**, respectively. Furthermore, the flexible substrate **51**, which is common to all of the ultrasonic transducers **52**, may be similar to the first flexible layer **31**.

[0043] FIG. **6A** is a schematic diagram illustrating the operation of an ultrasonic transducer **60** consistent with an example of the present invention. Referring to FIG. **6A**, the ultrasonic transducer **60** may be able to conform to a curved surface of an object **61**. Compared to the ultrasonic transducer **20** described and illustrated with reference to FIG. **2A**, attenuation of an ultrasonic wave transmitted from the ultrasonic transducer **60** may be alleviated.

[0044] FIG. **6B** is a diagram illustrating ultrasonic waves **62** and **64** from an array of the ultrasonic transducers **60** illustrated in FIG. **6A**. Referring to FIG. **6B**, the ultrasonic waves **62** and **64** from different ultrasonic transducers **60** of an ultrasonic transducer array may each transmit in the normal direction to the curved surface of the object **61** because the ultrasonic transducers **60** conform to the curved

surface. Accordingly, the angle of incidence " θ " and the angle of refraction " θ_1 " may substantially equal zero. Compared to the ultrasonic transducer 20 described and illustrated with reference to FIG. 2A, the issue of impedance mismatch may be alleviated.

[0045] FIG. 7 is a perspective view of an ultrasonic transducer array 70 consistent with an example of the present invention. Referring to FIG. 7, the ultrasonic transducer array 70 in the form of a flexible membrane may include a number of ultrasonic transducers (not numbered) and the first flexible layer 31 and first conductive layer 32 common to the number of ultrasonic transducers. Each of the number of ultrasonic transducers may include one chamber 38 and one conductor 37-1 disposed above the chamber 38. A plurality of conductive wires 71 may be formed simultaneously with the conductors 37-1 to electrically couple the conductors 37-1. Each of the conductive wires 71 may have a width ranging from approximately 3 to 20 μm .

[0046] FIG. 8 is a top planar view of an ultrasonic transducer array 80 consistent with an example of the present invention. Referring to FIG. 8, the ultrasonic transducer array 80 may include a number of ultrasonic transducers 81 electrically coupled to one another by the conductive wires 71. For each of the ultrasonic transducers 81, the shape of the second electrode 37-1 may include but is not limited to one of a hexagon, rectangle, triangle, polygon and circle. Furthermore, the shape of the chamber (not shown) may also include but is not limited to one of a hexagon, rectangle, triangle, polygon and circle.

[0047] It will be appreciated by those skilled in the art that changes could be made to the embodiments described above without departing from the broad inventive concept thereof. It is understood, therefore, that this invention is not limited to the particular embodiments disclosed, but it is intended to cover modifications within the spirit and scope of the present invention as defined by the appended claims.

[0048] Further, in describing representative embodiments of the present invention, the specification may have presented the method and/or process of the present invention as a particular sequence of steps. However, to the extent that the method or process does not rely on the particular order of steps set forth herein, the method or process should not be limited to the particular sequence of steps described. As one of ordinary skill in the art would appreciate, other sequences of steps may be possible. Therefore, the particular order of the steps set forth in the specification should not be construed as limitations on the claims. In addition, the claims directed to the method and/or process of the present invention should not be limited to the performance of their steps in the order written, and one skilled in the art can readily appreciate that the sequences may be varied and still remain within the spirit and scope of the present invention.

We claim:

1. An ultrasonic transducer comprising:
 - a flexible membrane;
 - a first electrode in the flexible membrane;
 - a second electrode in the flexible membrane; and
 - a chamber in the flexible membrane between the first electrode and the second electrode.
2. The ultrasonic transducer of claim 1, wherein the flexible membrane includes a polymeric material selected from one of polyimide, parylene and photoresist.

3. The ultrasonic transducer of claim 1, wherein the flexible membrane is conformable to a surface topology of an object.

4. The ultrasonic transducer of claim 1, wherein at least one of the first electrode or the second electrode includes a conductive material selected from one of aluminum (Al), aurum (Au), platinum (Pt) and copper (Cu).

5. The ultrasonic transducer of claim 1, wherein the flexible membrane includes multiple flexible layers and the chamber is surrounded by the multiple flexible layers of the flexible membrane.

6. The ultrasonic transducer of claim 1, wherein the first electrode is exposed to the chamber.

7. An ultrasonic transducer comprising:

- a first flexible layer;
- a first conductive layer over the first flexible layer;
- a second flexible layer over the first conductive layer;
- a chamber in the second flexible layer;
- a third flexible layer over the chamber; and
- a second conductive layer in the third flexible layer,

wherein a portion of the third flexible layer between the second conductive layer and the chamber is capable of generating acoustic waves in response to a voltage applied across the first conductive layer and the second conductive layer.

8. The ultrasonic transducer of claim 7, wherein each of the first, second and third flexible layers includes a polymeric material selected from one of polyimide, parylene and photoresist.

9. The ultrasonic transducer of claim 7, wherein at least one of the first conductive layer or the second conductive layer includes a material selected from one of aluminum (Al), aurum (Au), platinum (Pt) and copper (Cu).

10. The ultrasonic transducer of claim 7, wherein the first conductive layer is exposed to the chamber.

11. An ultrasonic transducer array comprising:

- a flexible substrate;
- a first conductive layer on the flexible substrate; and
- a number of ultrasonic transducers on the first conductive layer, each of the number of ultrasonic transducers comprising:
 - a flexible membrane over the first conductive layer;
 - a second conductive layer in the flexible membrane; and
 - a chamber in the membrane between the first conductive layer and the second conductive layer.

12. The ultrasonic transducer array of claim 11, wherein at least one of the flexible substrate or the flexible membrane includes a polymeric material selected from one of polyimide, parylene and photoresist.

13. The ultrasonic transducer array of claim 11, wherein the flexible substrate is conformable to a surface topology of an object.

14. The ultrasonic transducer array of claim 11, wherein at least one of the first conductive layer or the second conductive layer includes a conductive material selected from one of aluminum (Al), aurum (Au), platinum (Pt) and copper (Cu).

15. The ultrasonic transducer array of claim 11, wherein the first conductive layer is exposed to the chamber of each of the number of ultrasonic transducers.

16. The ultrasonic transducer array of claim 11 further comprising a plurality of conductive wires electrically coupling the second conductive layer of each of the number of ultrasonic transducers.

17. An ultrasonic transducer array comprising:

a first flexible layer;

a first conductive layer on the first flexible layer; and

a number of ultrasonic transducers on the first conductive layer, each of the number of ultrasonic transducers comprising:

a second flexible layer over the first conductive layer;

a chamber in the second flexible layer;

a third flexible layer over the chamber; and

a second conductive layer in the third flexible layer,

wherein a portion of the third flexible layer between the second conductive layer and the chamber is capable of generating acoustic waves in response to a voltage applied across the first conductive layer and the second conductive layer.

18. The ultrasonic transducer array of claim 17, wherein each of the first, second and third flexible layers includes a polymeric material selected from one of polyimide, parylene and photoresist.

19. The ultrasonic transducer array of claim 17, wherein at least one of the first conductive layer or the second conductive layer includes a conductive material selected from one of aluminum (Al), aurum (Au), platinum (Pt) and copper (Cu).

20. The ultrasonic transducer array of claim 17, wherein the first conductive layer is exposed to the chamber.

* * * * *

专利名称(译)	微型超声换能器		
公开(公告)号	US20080086056A1	公开(公告)日	2008-04-10
申请号	US11/870396	申请日	2007-10-10
[标]申请(专利权)人(译)	财团法人工业技术研究院		
申请(专利权)人(译)	工业技术研究院		
当前申请(专利权)人(译)	工业技术研究院		
[标]发明人	CHANG MING WEI DENG HSU CHENG FAN TIEN CHU LAI CHIH MIN LEE GWO SHIANG CHIU CHIA LIN		
发明人	CHANG, MING-WEI DENG, HSU-CHENG FAN, TIEN-CHU LAI, CHIH-MIN LEE, GWO-SHIANG CHIU, CHIA-LIN		
IPC分类号	A61B8/13		
CPC分类号	A61B8/00 G01S15/8925 G01H11/06		
外部链接	Espacenet USPTO		

摘要(译)

一种超声换能器，包括柔性膜，柔性膜中的第一电极，柔性膜中的第二电极，以及位于第一电极和第二电极之间的柔性膜中的腔室。

